DECEMBER 1983-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

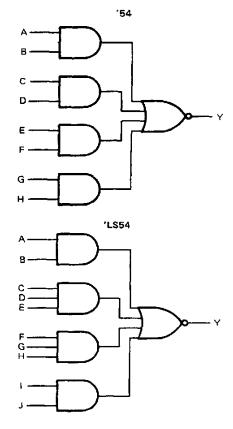
description

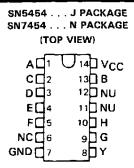
These devices contain 4-wide AND-OR-INVERT gates. They perform the following Boolean functions:

'54 Y =
$$\overrightarrow{AB}$$
 + \overrightarrow{CD} + \overrightarrow{EF} + \overrightarrow{GH}
LS54 Y = \overrightarrow{AB} + \overrightarrow{CDE} + \overrightarrow{FGH} + \overrightarrow{IJ}

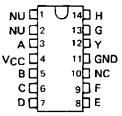
The SN5454 and SN54LS54 are characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to 125 $\,^{\circ}\text{C}$. The SN7454 and SN74LS54 are characterized for operation from 0 $\,^{\circ}\text{C}$ to 70 $\,^{\circ}\text{C}$.

logic diagrams (positive logic)

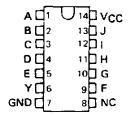




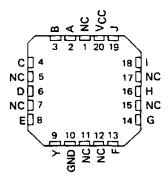
SN5454 . . . W PACKAGE (TOP VIEW)



SN54LS54 . . . J OR W PACKAGE SN74LS54 . . . D OR N PACKAGE (TOP VIEW)



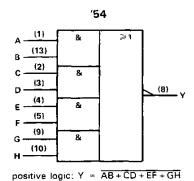
SN54LS54 . . . FK PACKAGE (TOP VIEW)

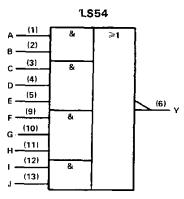


NC-No internal connection
NU-Make no external connection

SN5454, SN54LS54, SN7454, SN74LS54 4-WIDE AND-OR-INVERT GATES

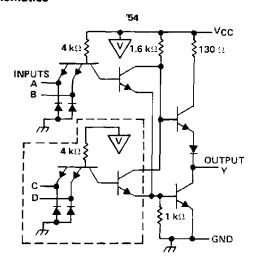
logic symbols†

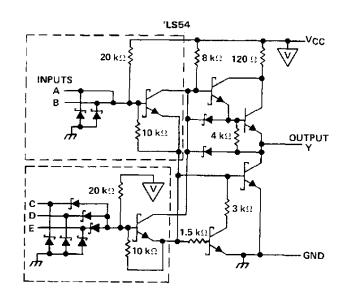




positive logic: $Y = \overline{AB + CDE + FGH + IJ}$

schematics





Resistor values shown are nominal.

The portion of the circuits within the dashed lines is repeated for each additional 2- or 3-input AND section, as shown in the logic diagram and logic symbols.

[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N package. For the SN54LS54 only, they apply also for the W package.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note	1)	7 V
Input voltage		5.5 V
Operating free-air temperature:	SN5454	-55°C to 125°C
	SN7454	0°C to 70°C
Storage temperature range		-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5454				SN7454			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT		
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V		
VIH	High-level input voltage	2			2			٧		
VIL	Low-level input voltage			9.0			8.0	٧		
	High-level output current			- 0.4		-	- 0.4	mΑ		
IOL	Low-level output current			16			16	mA		
	Operating free-air temperature	– 55		125	0		70	°C		

electrical characterics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONSTITUTE		SN5454				SN7454			
PARAMETER	TEST CONDITIONS†	MIN	TYP‡	MAX	MIN	TYP ‡	MAX	UNIT		
ViK	V _{CC} = MIN. I ₁ = - 12 mA			- 1.5			- 1.5	V		
νон	VCC = MIN, VIL = 0.8 V, IQH = -	0.4 mA 2	4 3.4		2.4	3.4		V		
VOL	V _{CC} = MIN. V _{1H} = 2 V, I _{OL} = 10	mA	0.2	0.4]	0.2	0.4	٧		
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA		
ΊΗ	V _{CC} = MAX, V _I = 2.4 V			40			40	μΑ		
l L	V _{CC} = MAX, V ₁ = 0.4 V			- 1.6			- 1.6	mA		
losÿ	V _{CC} = MAX	- 2	0	– 55	- 18		– 55	mA		
Іссн	V _{CC} = MAX, V _I = 0 V		4	8		4	8	mΑ		
ICCL	V _{CC} = MAX, See Note 2		5.1	9.5		5.1	9.5	mΑ		

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN TY	P MAX	UNIT
†PLH	0	,	$R_1 = 400 \Omega$, $C_1 = 15 pF$	1	3 22	ns
tPHL.	Апу	· · · · · · · · · · · · · · · · · · ·	A[- 400 32,		8 15	ns -

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

SN54LS54, SN74LS54 4-WIDE AND-OR-INVERT GATES

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note	1)	 	 	 	7 '	٧
Input voltage		 	 	 .	7 '	٧
Operating free-air temperature:	SN54LS54	 	 	 	-55°C to 125°	С
	SN74LS54	 	 	 	0°C to 70°C	С
Storage temperature range		 	 	 	-65°C to 150°C	С

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		s	SN54LS54			SN74LS54			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2			٧	
VIL	Low-level input voltage			0.7			8.0	V	
ІОН	High-level output current			- 0.4			- 0.4	mA	
OL	Low-level output current			4			8	mΑ	
τ _A	Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	!	S	N54LS	i4	S					
	•	TEST CONDIT	I IONS	MIN	TYP \$	MAX	MIN	TYP ‡	MAX	דומט
Vικ	VCC = MIN,	l ₁ = 18 mA				- 1.5			- 1.5	* V
Voн	VCC = MIN,	VIL = MAX,	OH = - 0.4 mA	2.5	3.4	-	2.7	3.4		V
VOL	V _{CC} = MIN,	V _{(H} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	
• OL	V _{CC} = MIN	V _{IH} = 2 V,	IOL = 8 mA					0.35	0.5	'
lj	VCC = MAX,	V ₁ = 7 V				0.1			0.1	mA
ЧН	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μА
	V _{CC} = MAX,	V ₁ = 0.4 V		7		- 0.4			- 0.4	mA
losş	V _{CC} = MAX	<u></u> -		- 20		- 100	- 20		– 100	mΑ
Іссн	V _{CC} = MAX,	V; = 0 V			8.0	1.6		8.0	1.6	mΑ
¹ CCL	V _{CC} = MAX,	See Note 2			1	2		1	2	mΑ

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	Anv	v	$R_1 \approx 2 k\Omega$, $C_1 = 15 pF$		12	20	ns
^t PHL				[12.5	20	กร

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at VCC = 5 V, TA = 25°C.

[§]Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.





15-Apr-2017

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN5454J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN5454J	Samples
SN54LS54J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS54J	Samples
SN54LS54J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS54J	Samples
SNJ5454J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ5454J	Samples
SNJ5454J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ5454J	Samples
SNJ54LS54J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS54J	Samples
SNJ54LS54J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS54J	Samples
SNJ54LS54W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS54W	Samples
SNJ54LS54W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS54W	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

in homogeneous material)

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



PACKAGE OPTION ADDENDUM

15-Apr-2017

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



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